



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED, AND MAY NOT BE IN BILL OF MATERIALS
 ASSEMBLY VARIANT: Standard Assembly

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PWR558	REV: A	SVN REV: Not In VersionControl
	IGNORE -> Bottom Overlay		
PLOT NAME = Bottom Assembly Drawing	GENERATED : 4/26/2013 12:30:22 PM	TEXAS INSTRUMENTS	

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